Triple RF Schottky Diode

These diodes are designed for analog and digital applications, including DC based signal detection and mixing applications.

Features:

- Low Capacitance (<1 pF)
- Low V_F (390 mV typical @ 1 mA)
- Low $V_{F\Delta}$ (1 mV typical @ 1 mA)

Benefits:

- Reduced Parasitic Losses
- Accurate Signal Measurement

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Reverse Voltage	V _R	15	V
Forward Current	١ _F	30	mA
Operating and Storage Temperature Range	T _J , T _{stg}	–65 to +150	°C
ESD Rating: Class 1 per Human Body Mode Class A per Machine Model	1		

THERMAL CHARACTERISTICS

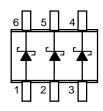
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance – Junction to Ambient	R_{\thetaJA}	500	°C/W



ON Semiconductor"

http://onsemi.com

RF SCHOTTKY BARRIER DIODES 15 VOLTS, 30 mA





SC-88 CASE 419B STYLE 15

MARKING DIAGRAM



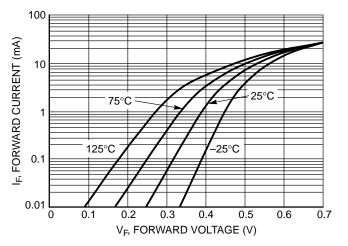
OZ = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping
NSR15TW1T2	SC-88	3000/Tape & Reel

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Breakdown Voltage (I _R = 10 μA)	V _{BR}	15	20	-	V
Reverse Leakage (V _R = 1 V)	I _R	-	2	50	nA
Forward Voltage (I _F = 1 mA)	V _{F1}	-	390	415	mV
Forward Voltage (I _F = 10 mA)	V _{F2}	-	530	680	mV
Delta V _F (I _F = 1 mA, All Diodes)	ΔV_F	-	1	15	mV
Capacitance (V _F = 0 V, f = 1 MHz)	CT	-	0.8	1	pF





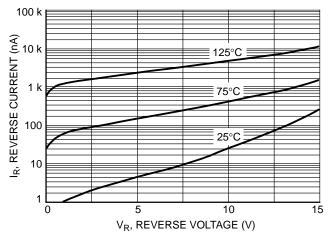


Figure 2. Reverse Current versus Reverse Voltage

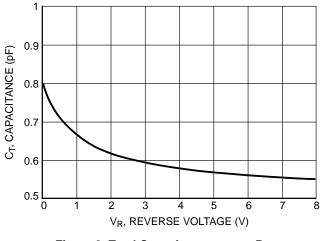


Figure 3. Total Capacitance versus Reverse Voltage

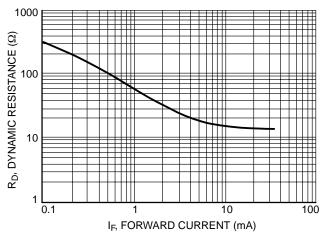


Figure 4. Dynamic Resistance versus Forward Current

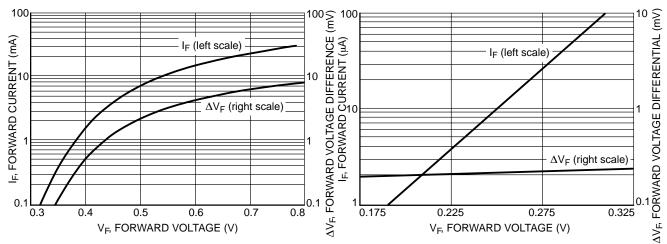
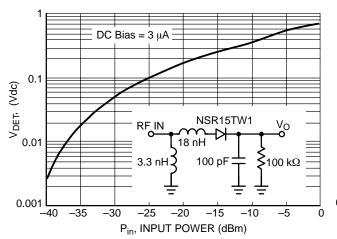


Figure 5. Typical V_F Match at Mixer Bias Levels

Figure 6. Typical V_F Match at Detector Bias Levels



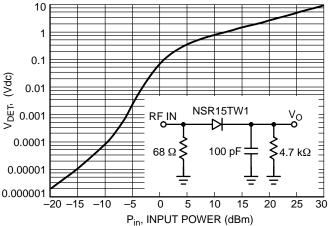




Figure 8. Typical Output Voltage versus Input Power, Large Signal Detector Operating at 915 MHz

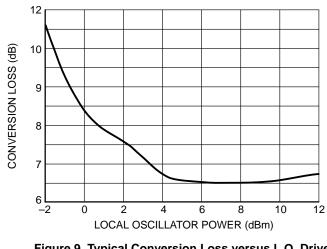
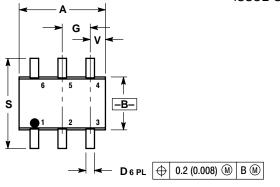
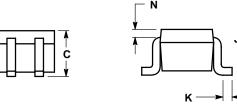


Figure 9. Typical Conversion Loss versus L.O. Drive, 2.0 GHz

PACKAGE DIMENSIONS

SC-88 (SOT-363) CASE 419B-01 ISSUE G





NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026 BSC		0.65 BSC		
Н		0.004		0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
Ν	0.008 REF		0.20	REF	
S	0.079	0.087	2.00	2.20	
۷	0.012	0.016	0.30	0.40	

STYLE 15:

PIN 1. ANODE 2. ANODE

3. ANODE 4. CATHODE 5. CATHODE

5. CATHODE 6. CATHODE

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